





an Open Access Journal by MDPI

# Advances and Applications in Ambient Intelligence and Smart Environments

Guest Editors:

Dr. Alberto Trombetta

Dr. Daniele Spoladore

Dr. Andrea Zangiacomi

Deadline for manuscript submissions:

closed (20 December 2022)

## **Message from the Guest Editors**

This Special Issue encourages the submission of highquality, original and innovative contributions regarding the application of AmI and AI in different areas. The list of possible topics includes (but is not limited to):

- Al and Aml-based applications in Smart Homes and Buildings;
- Al and Aml-based applications exploiting wearable systems to deliver personalized indoor services;
- Al and Aml-based Telehealthcare systems;
- Al and Aml for the management and optimization of energy in domestic and commercial buildings;
- Novel AI and AmI approaches to activity recognition in indoor environments;
- AmI and AI-enabled smart working places and public spaces (parks, squares, beaches, gardens, etc.) applications;
- Societal challenges in the adoption of AI and Amlbased technologies for smart society (ethical issues, privacy concerns, non-invasive approaches, stigma, willingness to adopt, accessibility issues);
- The role of Human factors in the design and development of Aml environments;
- Impact of the COVID-19 pandemic on the application of AmI and smart environments.











an Open Access Journal by MDPI

### **Editor-in-Chief**

# **Prof. Dr. Giulio Nicola Cerullo**Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

# **Message from the Editor-in-Chief**

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

### **Author Benefits**

**Open Access:** free for readers, with article processing charges (APC) paid by authors or their institutions.

**High Visibility:** indexed within Scopus, SCIE (Web of Science), Inspec, CAPlus / SciFinder, and other databases.

**Journal Rank:** JCR - Q1 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

#### **Contact Us**